

DATA SHEET

LTE42012R

NPN microwave power transistor

Product specification
Supersedes data of June 1992

1997 Feb 21

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FEATURES

- Interdigitated structure provides high emitter efficiency
- Diffused emitter ballasting resistor provides excellent current sharing and withstanding a high VSWR
- Gold metallization realizes very stable characteristics and excellent lifetime
- Multicell geometry gives good balance of dissipated power and low thermal resistance
- Input matching cell improves input impedance and allows an easier design of wideband circuits.

APPLICATIONS

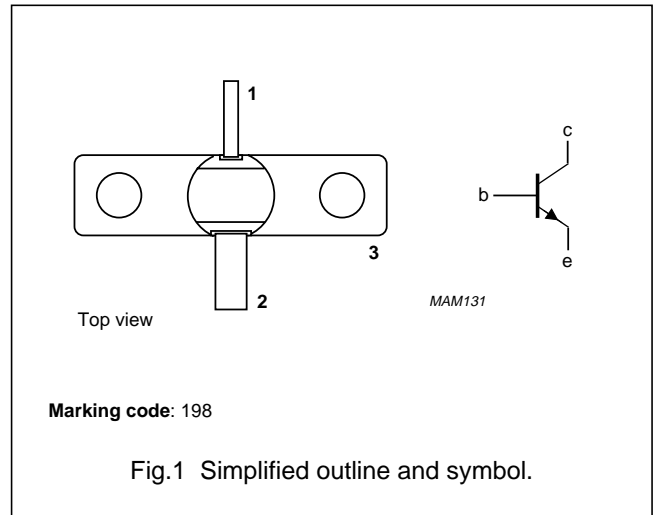
- Common emitter class-A power amplifiers up to 4.2 GHz in CW conditions for military and professional applications.

DESCRIPTION

NPN silicon planar epitaxial microwave power transistor in a SOT440A metal ceramic flange package with the emitter connected to the flange.

PINNING - SOT440A

PIN	DESCRIPTION
1	collector
2	base
3	emitter connected to flange



QUICK REFERENCE DATA

Microwave performance up to $T_{mb} = 25\text{ }^{\circ}\text{C}$ in a common emitter class-A selective amplifier.

MODE OF OPERATION	f (GHz)	V _{CE} (V)	I _C (mA)	P _{L1} (W)	G _{po} (dB)	Z _i (Ω)	Z _L (Ω)
Class-A (CW)	4.2	16	400	≥1	≥6	7.5 + j12	4 - j8

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO slab is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

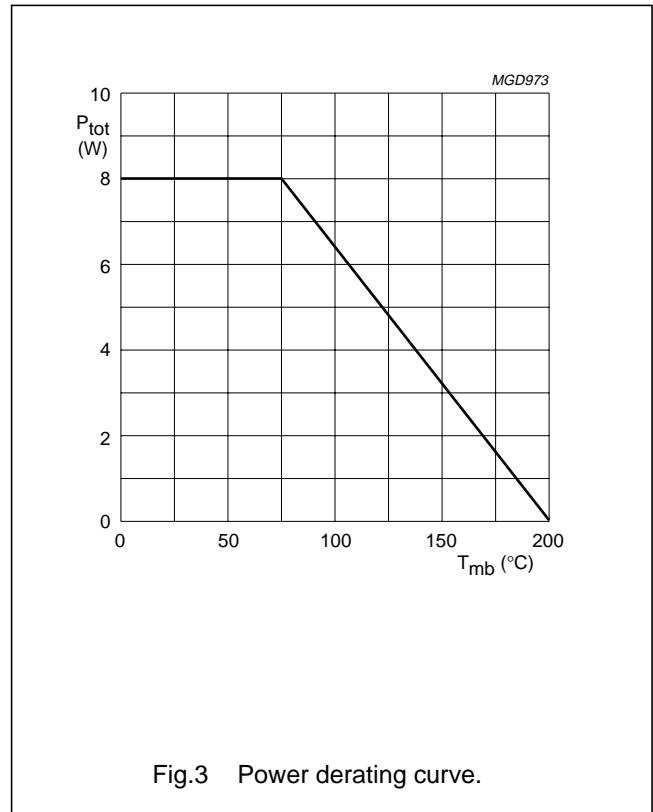
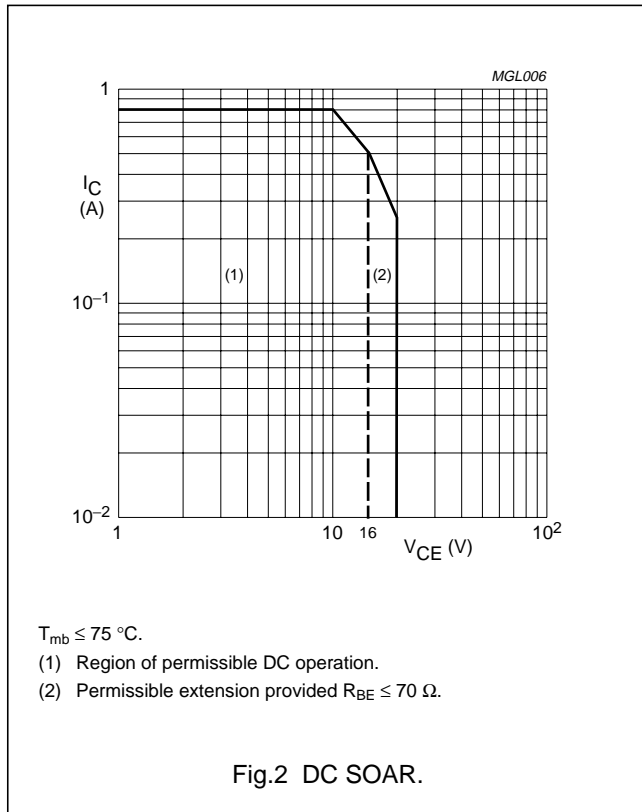
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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	40	V
V_{CER}	collector-emitter voltage	$R_{BE} = 70 \Omega$	–	20	V
V_{CEO}	collector-emitter voltage	open base	–	16	V
I_C	collector current (DC)		–	800	mA
P_{tot}	total power dissipation	$T_{mb} \leq 75 \text{ }^\circ\text{C}$	–	8	W
T_{stg}	storage temperature		–65	+200	$^\circ\text{C}$
T_j	operating junction temperature		–	200	$^\circ\text{C}$
T_{sld}	soldering temperature	at 0.1 mm from ceramic; $t \leq 10 \text{ s}$	–	235	$^\circ\text{C}$



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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
$R_{th\ j-mb}$	thermal resistance from junction to mounting-base	$T_j = 75\text{ °C}$	10	K/W
$R_{th\ mb-h}$	thermal resistance from mounting-base to heatsink	$T_j = 75\text{ °C}$; note 1	0.7	K/W

Note

1. See "Mounting recommendations in the General part of handbook SC19a".

CHARACTERISTICS

$T_{mb} = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector cut-off current	$V_{CB} = 20\text{ V}$; $I_E = 0$	–	–	200	μA
I_{EBO}	emitter cut-off current	$V_{EB} = 1.5\text{ V}$; $I_C = 0$	–	–	600	nA
h_{FE}	DC current gain	$V_{CE} = 5\text{ V}$; $I_C = 400\text{ mA}$	15	–	100	
C_{cb}	collector-base capacitance	$V_{CB} = 16\text{ V}$; $V_{EB} = 1.5\text{ V}$; $I_E = I_C = 0$; $f = 1\text{ MHz}$	–	3	–	pF
C_{ce}	collector-emitter capacitance	$V_{CE} = 16\text{ V}$; $V_{EB} = 1.5\text{ V}$; $I_E = I_C = 0$; $f = 1\text{ MHz}$	–	1.5	–	pF
C_{eb}	emitter-base capacitance	$V_{CB} = 10\text{ V}$; $V_{EB} = 1\text{ V}$; $I_C = I_E = 0$; $f = 1\text{ MHz}$	–	28	–	pF

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Table 1 Common-emitter scattering parameters: $V_{CE} = 16\text{ V}$; $I_C = 400\text{ mA}$; $T_{mb} = 25\text{ °C}$; $Z_o = 50\ \Omega$; typical values.

f (MHz)	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)	MAGNITUDE (ratio)	ANGLE (deg)
2000	0.84	163	0.049	64	0.96	47.2	0.60	179.3
2100	0.84	161	0.051	62.7	0.94	43.3	0.59	178.0
2200	0.84	159	0.054	60.4	0.93	39.8	0.59	175.6
2300	0.85	158	0.055	58.8	0.91	36.2	0.59	174.2
2400	0.85	156	0.057	57.5	0.91	32.2	0.60	172.6
2500	0.85	155	0.060	56.1	0.90	29.1	0.60	171.1
2600	0.85	154	0.064	54.9	0.89	24.6	0.60	169.8
2700	0.85	153	0.067	53.1	0.89	21.2	0.60	168.6
2800	0.85	152	0.071	51.3	0.89	17.2	0.61	167.1
2900	0.84	150	0.073	49.5	0.90	13.8	0.62	165.7
3000	0.83	149	0.076	48.0	0.90	9.3	0.62	164.7
3100	0.82	149	0.080	46.0	0.91	5.2	0.63	163.8
3200	0.80	147	0.084	44.1	0.92	0.6	0.64	163.0
3300	0.78	146	0.088	40.5	0.93	-4.3	0.65	161.5
3400	0.76	145	0.091	36.1	0.95	-9.7	0.67	160.9
3500	0.74	144	0.093	34.4	0.97	-16.1	0.69	159.6
3600	0.71	143	0.095	30.7	0.98	-23.2	0.70	158.3
3700	0.70	142	0.095	26.3	0.99	-30.6	0.73	156.2
3800	0.67	142	0.093	21.6	0.99	-37.9	0.76	153.6
3900	0.66	142	0.091	17.0	1.00	-46.6	0.79	150.7
4000	0.64	142	0.088	13.2	0.98	-55.8	0.82	147.0
4100	0.64	142	0.084	9.7	0.95	-64.9	0.85	143.1
4200	0.65	143	0.077	7.0	0.91	-73.8	0.88	138.4
4300	0.67	143	0.068	5.9	0.86	-82.6	0.90	133.6
4400	0.69	143	0.060	8.2	0.81	-92.3	0.93	129.3
4500	0.72	141	0.054	13.8	0.74	-101.7	0.94	124.9
4600	0.75	139	0.050	20.5	0.68	-110.6	0.95	120.1
4700	0.76	137	0.050	31.2	0.61	-119.7	0.96	116.5
4800	0.78	135	0.054	43.5	0.56	-129.1	0.97	113.5
4900	0.79	133	0.061	46.6	0.50	-139.5	0.97	110.1
5000	0.77	130	0.068	54.3	0.44	-148.6	0.97	106.7

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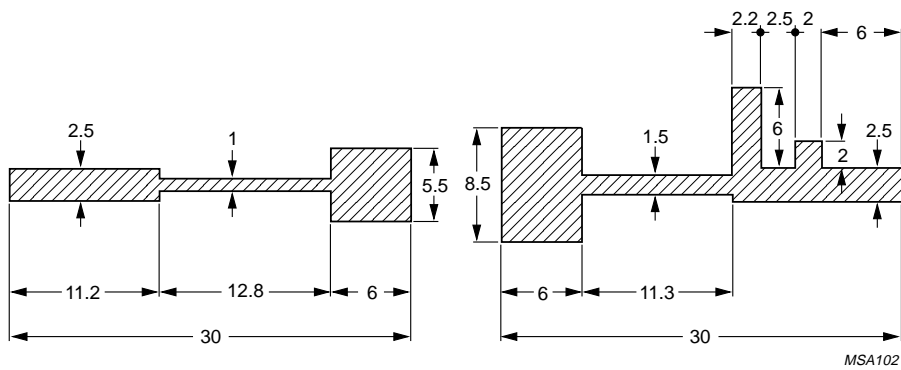
APPLICATION INFORMATION

Microwave performance up to $T_{mb} = 25\text{ }^{\circ}\text{C}$ in a common emitter class-A selective circuit; note 1.

MODE OF OPERATION	f (GHz)	V _{CE} (V)	I _c (mA)	P _{L1} (W)	G _{po} (dB)	Z _i (Ω)	Z _L (Ω)
Class-A	4.2	16	400	>1 typ. 1.25	>6 typ. 7	7.5 + j12	4 - j8

Note

1. Circuit consists of prematching circuit boards in combination with complementary input and output slug tuners.



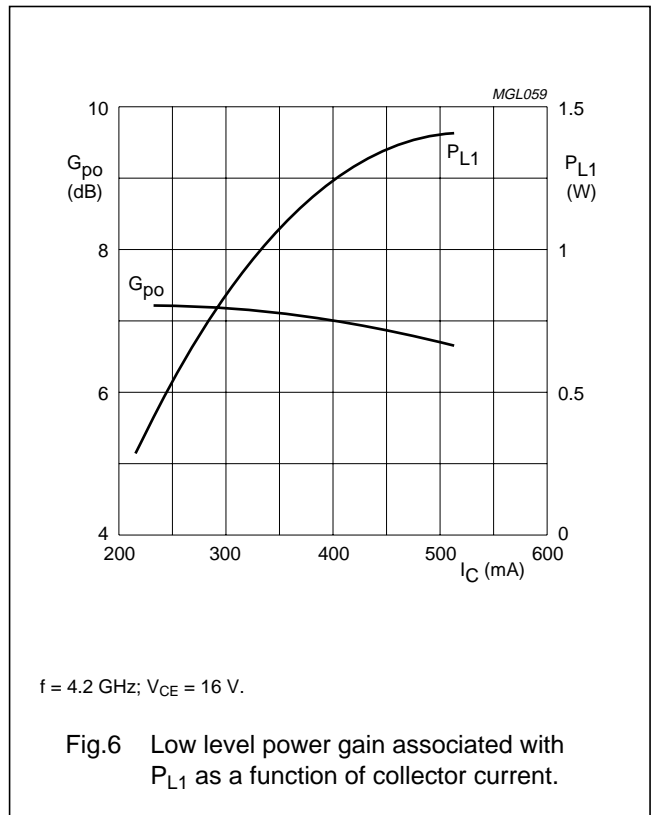
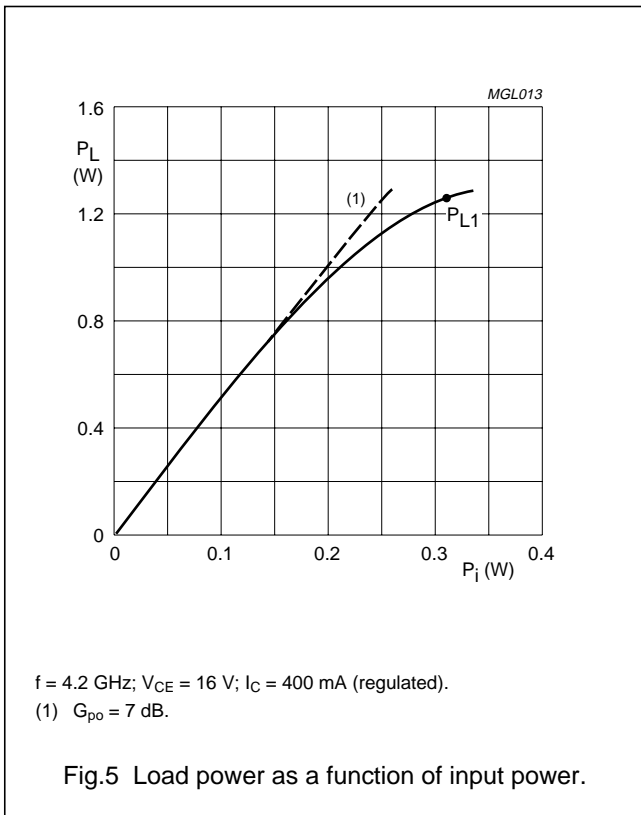
Dimensions in mm.

Input striplines on a double copper-clad printed-circuit board with PTFE fibreglass dielectric ($\epsilon_r = 2.54$); thickness: 0.8 mm.

Fig.4 Prematching test circuit board.

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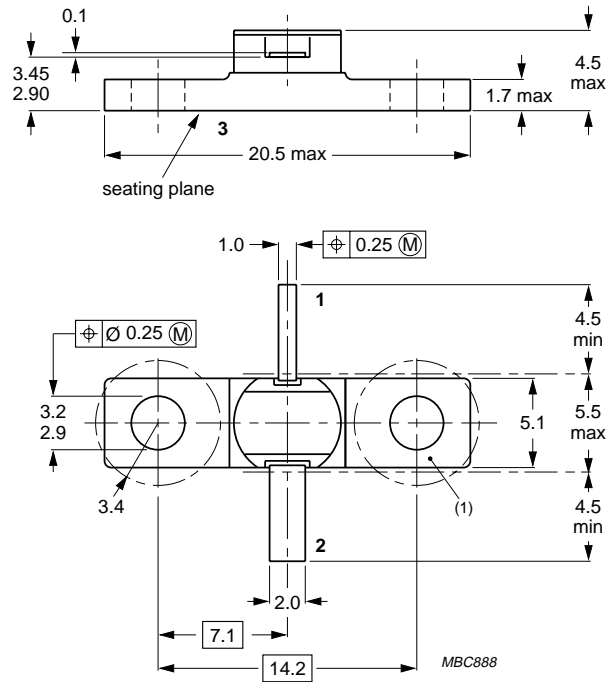
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PACKAGE OUTLINE



Dimensions in mm.
 Torque on screw: Max. 0.4 Nm
 Recommended screw: M2.5

(1) Flatness of this area ensures full thermal contact with bolt head.

Fig.7 SOT440A.

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DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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NOTES

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NOTES

Philips Semiconductors – a worldwide company

Argentina: see South America

Australia: 34 Waterloo Road, NORTH RYDE, NSW 2113,
Tel. +61 2 9805 4455, Fax. +61 2 9805 4466

Austria: Computerstr. 6, A-1101 WIEN, P.O. Box 213,
Tel. +43 1 60 101, Fax. +43 1 60 101 1210

Belarus: Hotel Minsk Business Center, Bld. 3, r. 1211, Volodarski Str. 6,
220050 MINSK, Tel. +375 172 200 733, Fax. +375 172 200 773

Belgium: see The Netherlands

Brazil: see South America

Bulgaria: Philips Bulgaria Ltd., Energoproject, 15th floor,
51 James Bourchier Blvd., 1407 SOFIA,
Tel. +359 2 689 211, Fax. +359 2 689 102

Canada: PHILIPS SEMICONDUCTORS/COMPONENTS,
Tel. +1 800 234 7381

China/Hong Kong: 501 Hong Kong Industrial Technology Centre,
72 Tat Chee Avenue, Kowloon Tong, HONG KONG,
Tel. +852 2319 7888, Fax. +852 2319 7700

Colombia: see South America

Czech Republic: see Austria

Denmark: Prags Boulevard 80, PB 1919, DK-2300 COPENHAGEN S,
Tel. +45 32 88 2636, Fax. +45 31 57 1949

Finland: Sinikalliontie 3, FIN-02630 ESPOO,
Tel. +358 9 615800, Fax. +358 9 61580/xxx

France: 4 Rue du Port-aux-Vins, BP317, 92156 SURESNES Cedex,
Tel. +33 1 40 99 6161, Fax. +33 1 40 99 6427

Germany: Hammerbrookstraße 69, D-20097 HAMBURG,
Tel. +49 40 23 53 60, Fax. +49 40 23 536 300

Greece: No. 15, 25th March Street, GR 17778 TAVROS/ATHENS,
Tel. +30 1 4894 339/239, Fax. +30 1 4814 240

Hungary: see Austria

India: Philips INDIA Ltd, Shivsagar Estate, A Block, Dr. Annie Besant Rd.
Worli, MUMBAI 400 018, Tel. +91 22 4938 541, Fax. +91 22 4938 722

Indonesia: see Singapore

Ireland: Newstead, Clonskeagh, DUBLIN 14,
Tel. +353 1 7640 000, Fax. +353 1 7640 200

Israel: RAPAC Electronics, 7 Kehilat Saloniki St, TEL AVIV 61180,
Tel. +972 3 645 0444, Fax. +972 3 649 1007

Italy: PHILIPS SEMICONDUCTORS, Piazza IV Novembre 3,
20124 MILANO, Tel. +39 2 6752 2531, Fax. +39 2 6752 2557

Japan: Philips Bldg 13-37, Kohnan 2-chome, Minato-ku, TOKYO 108,
Tel. +81 3 3740 5130, Fax. +81 3 3740 5077

Korea: Philips House, 260-199 Itaewon-dong, Yongsan-ku, SEOUL,
Tel. +82 2 709 1412, Fax. +82 2 709 1415

Malaysia: No. 76 Jalan Universiti, 46200 PETALING JAYA, SELANGOR,
Tel. +60 3 750 5214, Fax. +60 3 757 4880

Mexico: 5900 Gateway East, Suite 200, EL PASO, TEXAS 79905,
Tel. +9-5 800 234 7381

Middle East: see Italy

Netherlands: Postbus 90050, 5600 PB EINDHOVEN, Bldg. VB,
Tel. +31 40 27 82785, Fax. +31 40 27 88399

New Zealand: 2 Wagener Place, C.P.O. Box 1041, AUCKLAND,
Tel. +64 9 849 4160, Fax. +64 9 849 7811

Norway: Box 1, Manglerud 0612, OSLO,
Tel. +47 22 74 8000, Fax. +47 22 74 8341

Philippines: Philips Semiconductors Philippines Inc.,
106 Valero St. Salcedo Village, P.O. Box 2108 MCC, MAKATI,
Metro MANILA, Tel. +63 2 816 6380, Fax. +63 2 817 3474

Poland: Ul. Lukiska 10, PL 04-123 WARSZAWA,
Tel. +48 22 612 2831, Fax. +48 22 612 2327

Portugal: see Spain

Romania: see Italy

Russia: Philips Russia, Ul. Usatcheva 35A, 119048 MOSCOW,
Tel. +7 095 755 6918, Fax. +7 095 755 6919

Singapore: Lorong 1, Toa Payoh, SINGAPORE 1231,
Tel. +65 350 2538, Fax. +65 251 6500

Slovakia: see Austria

Slovenia: see Italy

South Africa: S.A. PHILIPS Pty Ltd., 195-215 Main Road Martindale,
2092 JOHANNESBURG, P.O. Box 7430 Johannesburg 2000,
Tel. +27 11 470 5911, Fax. +27 11 470 5494

South America: Rua do Rocio 220, 5th floor, Suite 51,
04552-903 São Paulo, SÃO PAULO - SP, Brazil,
Tel. +55 11 821 2333, Fax. +55 11 829 1849

Spain: Balmes 22, 08007 BARCELONA,
Tel. +34 3 301 6312, Fax. +34 3 301 4107

Sweden: Kottbygatan 7, Akalla, S-16485 STOCKHOLM,
Tel. +46 8 632 2000, Fax. +46 8 632 2745

Switzerland: Allmendstrasse 140, CH-8027 ZÜRICH,
Tel. +41 1 488 2686, Fax. +41 1 481 7730

Taiwan: Philips Semiconductors, 6F, No. 96, Chien Kuo N. Rd., Sec. 1,
TAIPEI, Taiwan Tel. +886 2 2134 2870, Fax. +886 2 2134 2874

Thailand: PHILIPS ELECTRONICS (THAILAND) Ltd.,
209/2 Sanpavuth-Bangna Road Prakanong, BANGKOK 10260,
Tel. +66 2 745 4090, Fax. +66 2 398 0793

Turkey: Talatpasa Cad. No. 5, 80640 GÜLTEPE/ISTANBUL,
Tel. +90 212 279 2770, Fax. +90 212 282 6707

Ukraine: PHILIPS UKRAINE, 4 Patrice Lumumba str., Building B, Floor 7,
252042 KIEV, Tel. +380 44 264 2776, Fax. +380 44 268 0461

United Kingdom: Philips Semiconductors Ltd., 276 Bath Road, Hayes,
MIDDLESEX UB3 5BX, Tel. +44 181 730 5000, Fax. +44 181 754 8421

United States: 811 East Arques Avenue, SUNNYVALE, CA 94088-3409,
Tel. +1 800 234 7381

Uruguay: see South America

Vietnam: see Singapore

Yugoslavia: PHILIPS, Trg N. Pasica 5/v, 11000 BEOGRAD,
Tel. +381 11 625 344, Fax. +381 11 635 777

For all other countries apply to: Philips Semiconductors, Marketing & Sales Communications,
Building BE-p, P.O. Box 218, 5600 MD EINDHOVEN, The Netherlands, Fax. +31 40 27 24825

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